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Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	eZ8
Core Size	8-Bit
Speed	20MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, LED, POR, PWM, WDT
Number of I/O	25
Program Memory Size	2KB (2K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f0231sj020sg

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CPU and Peripheral Overview

The eZ8 CPU, Zilog's latest 8-bit CPU, meets the continuing demand for faster and more code-efficient microcontrollers. The eZ8 CPU executes a superset of the original Z8 instruction set. The eZ8 CPU features include:

- Direct register-to-register architecture allows each register to function as an accumulator, improving execution time and decreasing the required program memory
- Software stack allows much greater depth in subroutine calls and interrupts than hardware stacks
- Compatible with existing Z8 CPU code
- Expanded internal register file allows access up to 4KB
- New instructions improve execution efficiency for code developed using high-level programming languages, including C
- Pipelined instruction fetch and execution
- New instructions for improved performance including BIT, BSWAP, BTJ, CPC, LDC, LDCI, LEA, MULT and SRL
- New instructions support 12-bit linear addressing of the register file
- Up to 10 MIPS operation
- C Compiler-friendly
- 2 to 9 clock cycles per instruction

For more information about the eZ8 CPU, refer to the [eZ8 CPU Core User Manual \(UM0128\)](#), which is available for download on www.zilog.com.

General Purpose Input/Output

The Z8 Encore! F0830 Series features up to 25 port pins (Ports A–D) for general-purpose input/output (GPIO). The number of GPIO pins available is a function of package. Each pin is individually programmable.

Flash Controller

The Flash Controller programs and erases the Flash memory. It also supports protection against accidental programming and erasure.

Table 8. Register File Address Map (Continued)

Address (Hex)	Register Description	Mnemonic	Reset (Hex)	Page No.
Analog-to-Digital Converter (ADC, cont'd)				
F73	ADC data low bits	ADCD_L	XX	103
F74	ADC sample settling time	ADCSST	0F	104
F75	ADC sample time	ADCST	3F	105
F76	Reserved	—	XX	
F77–F7F	Reserved	—	XX	
Low Power Control				
F80	Power control 0	PWRCTL0	88	32
F81	Reserved	—	XX	
LED Controller				
F82	LED drive enable	LEDEN	00	51
F83	LED drive level high	LEDLVLH	00	51
F84	LED drive level low	LEDLVLL	00	52
F85	Reserved	—	XX	
Oscillator Control				
F86	Oscillator control	OSCCTL	A0	154
F87–F8F	Reserved	—	XX	
Comparator 0				
F90	Comparator 0 control	CMP0	14	107
F91–FBF	Reserved	—	XX	
Interrupt Controller				
FC0	Interrupt request 0	IRQ0	00	58
FC1	IRQ0 enable high bit	IRQ0ENH	00	61
FC2	IRQ0 enable low Bit	IRQ0ENL	00	61
FC3	Interrupt request 1	IRQ1	00	59
FC4	IRQ1 enable high bit	IRQ1ENH	00	62
FC5	IRQ1 enable low bit	IRQ1ENL	00	63
FC6	Interrupt request 2	IRQ2	00	60
FC7	IRQ2 enable high bit	IRQ2ENH	00	64
FC8	IRQ2 enable low bit	IRQ2ENL	00	64
FC9–FCC	Reserved	—	XX	
FCD	Interrupt edge select	IRQES	00	66

Note: XX = Undefined.

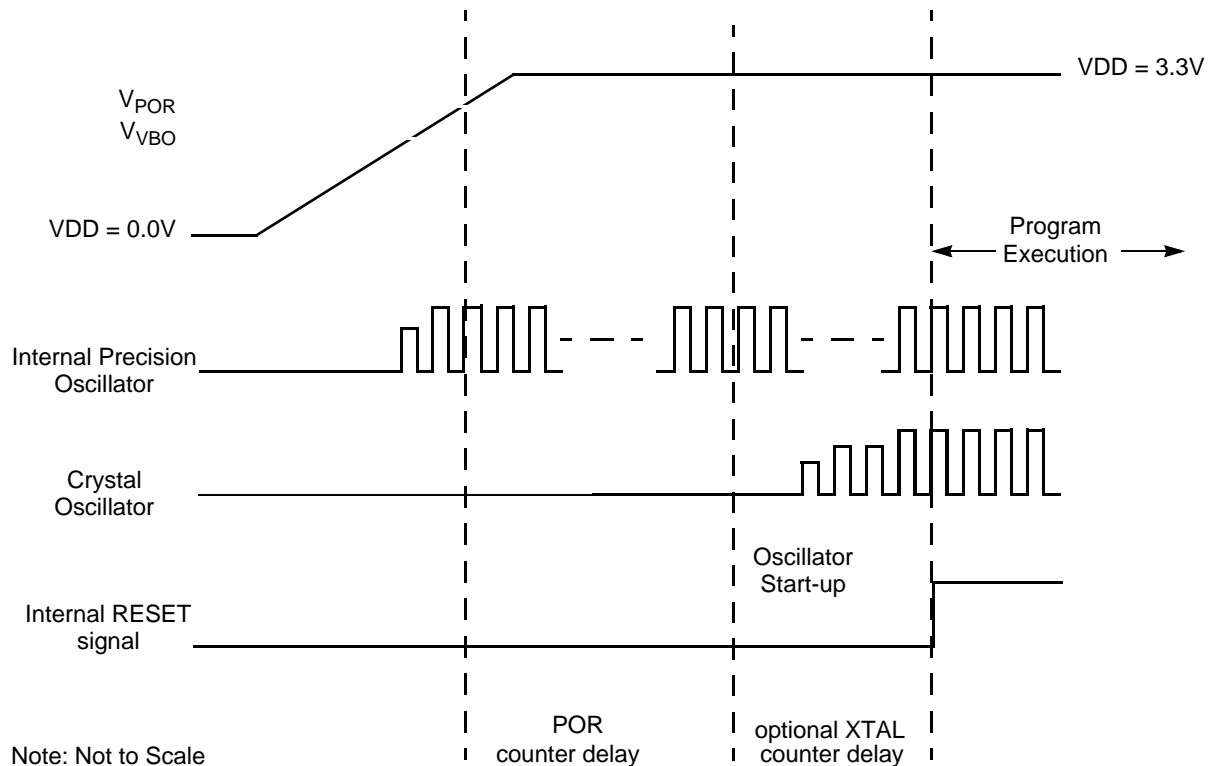


Figure 6. Power-On Reset Operation

Voltage Brown-Out Reset

The devices in the Z8 Encore! F0830 Series provide low Voltage Brown-Out (VBO) protection. The VBO circuit forces the device to the Reset state, when the supply voltage drops below the VBO threshold voltage (unsafe level). While the supply voltage remains below the Power-On Reset threshold voltage (V_{POR}), the VBO circuit holds the device in reset.

After the supply voltage exceeds the Power-On Reset threshold voltage, the device progresses through a full system reset sequence, as described in the POR section. Following Power-On Reset, the POR status bit in the Reset Status (RSTSTAT) Register is set to 1. Figure 7 displays the Voltage Brown-Out operation. See the [Electrical Characteristics](#) chapter on page 184 for the VBO and POR threshold voltages (V_{VBO} and V_{POR}).

The POR level is greater than the VBO level by the specified hysteresis value. This ensures that the device undergoes a POR after recovering from a VBO condition.

► **Note:** This register is only reset during a Power-On Reset sequence. Other system reset events do not affect it.

Table 14. Power Control Register 0 (PWRCTL0)

Bit	7	6	5	4	3	2	1	0
Field	Reserved			VBO	Reserved	Reserved	COMP	Reserved
RESET	1	0	0	0	1	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F80H							

Bit	Description
[7:5]	Reserved These registers are reserved and must be programmed to 000.
[4] VBO	Voltage Brown-Out detector disable This bit takes only effect when the VBO_AO Flash option bit is disabled. In STOP Mode, VBO is always disabled when the VBO_AO Flash option bit is disabled. To learn more about the VBO_AO Flash option bit function, see the Flash Option Bits chapter on page 124. 0 = VBO enabled. 1 = VBO disabled.
[3]	Reserved This bit is reserved and must be programmed to 1.
[2]	Reserved This bit is reserved and must be programmed to 0.
[1] COMP	Comparator Disable 0 = Comparator is enabled. 1 = Comparator is disabled.
[0]	Reserved This bit is reserved and must be programmed to 0.

Port A–D Control Registers

The Port A–D Control registers, shown in Table 20, set the GPIO port operation. The value in the corresponding Port A–D Address Register determines which subregister is read from or written to by a Port A–D Control Register transaction.

Table 20. Port A–D Control Registers (PxCTL)

Bit	7	6	5	4	3	2	1	0
Field	PCTL							
RESET	00H							
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	FD1H, FD5H, FD9H, FDDH							

Bit	Description
[7:0] PCTL	Port Control The Port Control Register provides access to all subregisters that configure the GPIO port operation.

Port A–D Data Direction Subregisters

The Port A–D Data Direction Subregister, shown in Table 21, is accessed through the Port A–D Control Register by writing 01H to the Port A–D Address Register.

Table 21. Port A–D Data Direction Subregisters (PxDD)

Bit	7	6	5	4	3	2	1	0
Field	DD7	DD6	DD5	DD4	DD3	DD2	DD1	DD0
RESET	1	1	1	1	1	1	1	1
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	If 01H in Port A–D Address Register, accessible through the Port A–D Control Register							

Bit	Description
[7:0] DDx	Data Direction These bits control the direction of the associated port pin. Port Alternate Function operation overrides the Data Direction Register setting. 0 = Output. Data in the Port A–D Output Data Register is driven onto the port pin. 1 = Input. The port pin is sampled and the value written into the Port A–D Input Data Register. The output driver is tristated.

Note: x indicates the specific GPIO port pin number (7–0).

- Writing 1 to the IRQE bit in the Interrupt Control Register

Interrupts are globally disabled by any of the following actions:

- Execution of a DI (disable interrupt) instruction
- eZ8 CPU acknowledgement of an interrupt service request from the Interrupt Controller
- Writing a 0 to the IRQE bit in the Interrupt Control Register
- Reset
- Execution of a trap instruction
- Illegal instruction Trap
- Primary oscillator fail trap
- Watchdog Oscillator fail trap

Interrupt Vectors and Priority

The Interrupt Controller supports three levels of interrupt priority. Level 3 is the highest priority, level 2 is the second highest priority and level 1 is the lowest priority. If all of the interrupts are enabled with identical interrupt priority (all as level 2 interrupts, for example), the interrupt priority is assigned from highest to lowest as specified in [Table 34](#) on page 54. Level 3 interrupts are always assigned higher priority than level 2 interrupts and level 2 interrupts are assigned higher priority than level 1 interrupts. Within each interrupt priority level (level 1, level 2 or level 3), priority is assigned as specified in [Table 34](#), above. Reset, Watchdog Timer interrupt (if enabled), primary oscillator fail trap, Watchdog Oscillator fail trap and illegal instruction trap always have highest (level 3) priority.

Interrupt Assertion

Interrupt sources assert their interrupt requests for only a single system clock period (single pulse). When the interrupt request is acknowledged by the eZ8 CPU, the corresponding bit in the interrupt request register is cleared. Writing 0 to the corresponding bit in the interrupt request register clears the interrupt request.

! **Caution:** Zilog recommends not using a coding style that clears bits in the Interrupt Request registers. All incoming interrupts received between execution of the first LDX command and the final LDX command are lost. See Example 1, which follows.

Example 1. A poor coding style that can result in lost interrupt requests:

5. Enable the timer interrupt, if appropriate and set the timer interrupt priority by writing to the relevant interrupt registers. By default, the timer interrupt is generated for both input capture and Reload events. If appropriate, configure the timer interrupt to be generated only at the input capture event or the reload event by setting the TICONFIG field of the TxCTL1 Register.
6. Configure the associated GPIO port pin for the timer input alternate function.
7. Write to the Timer Control Register to enable the timer and initiate counting.

In CAPTURE Mode, the elapsed time between the timer start and the capture event can be calculated using the following equation:

$$\text{Capture Elapsed Time (s)} = \frac{(\text{Capture Value} - \text{Start Value}) \times \text{Prescale}}{\text{System Clock Frequency (Hz)}}$$

CAPTURE RESTART Mode

In CAPTURE RESTART Mode, the current timer count value is recorded when the acceptable external timer input transition occurs. The capture count value is written to the timer PWM High and Low Byte registers. The timer input is the system clock. The TPOL bit in the Timer Control Register determines whether the capture occurs on a rising edge or a falling edge of the timer input signal. When the capture event occurs, an interrupt is generated and the count value in the Timer High and Low Byte registers is reset to 0001H and counting resumes. The INPCAP bit in the TxCTL1 Register is set to indicate that the timer interrupt has been caused by an input capture event.

If no capture event occurs, the timer counts up to 16-bit compare value stored in the Timer Reload High and Low Byte registers. Upon reaching the reload value, the timer generates an interrupt, the count value in the Timer High and Low Byte registers is reset to 0001H and counting resumes. The INPCAP bit in the TxCTL1 Register is cleared to indicate that the timer interrupt has not been caused by an input capture event.

Observe the following steps for configuring a timer for CAPTURE RESTART Mode and for initiating the count:

1. Write to the Timer Control Register to:
 - Disable the timer
 - Configure the timer for CAPTURE RESTART Mode; setting the mode also involves writing to TMODEHI bit in the TxCTL1 Register
 - Set the prescale value
 - Set the capture edge (rising or falling) for the timer input
2. Write to the Timer High and Low Byte registers to set the starting count value (typically 0001H).

Comparator

The Z8 Encore! F0830 Series devices feature a general purpose comparator that compares two analog input signals. A GPIO (CINP) pin provides the positive comparator input. The negative input (CINN) can be taken from either an external GPIO pin or from an internal reference. The output is available as an interrupt source or can be routed to an external pin using the GPIO multiplex. The comparator includes the following features:

- Positive input is connected to a GPIO pin
- Negative input can be connected to either a GPIO pin or a programmable internal reference
- Output can be either an interrupt source or an output to an external pin

Operation

One of the comparator inputs can be connected to an internal reference that is a user-selectable reference and is user-programmable with 200mV resolution.

The comparator can be powered down to save supply current. For details, see the [Power Control Register 0](#) section on page 31.

! Caution: As a result of the propagation delay of the comparator, Zilog does not recommend enabling the comparator without first disabling interrupts and waiting for the comparator output to settle. This delay prevents spurious interrupts after comparator enabling.

The following example shows how to safely enable the comparator:

```
di
ld cmp0,r0; load some new configuration
nop
nop      ; wait for output to settle
clr irq0 ; clear any spurious interrupts pending
ei
```

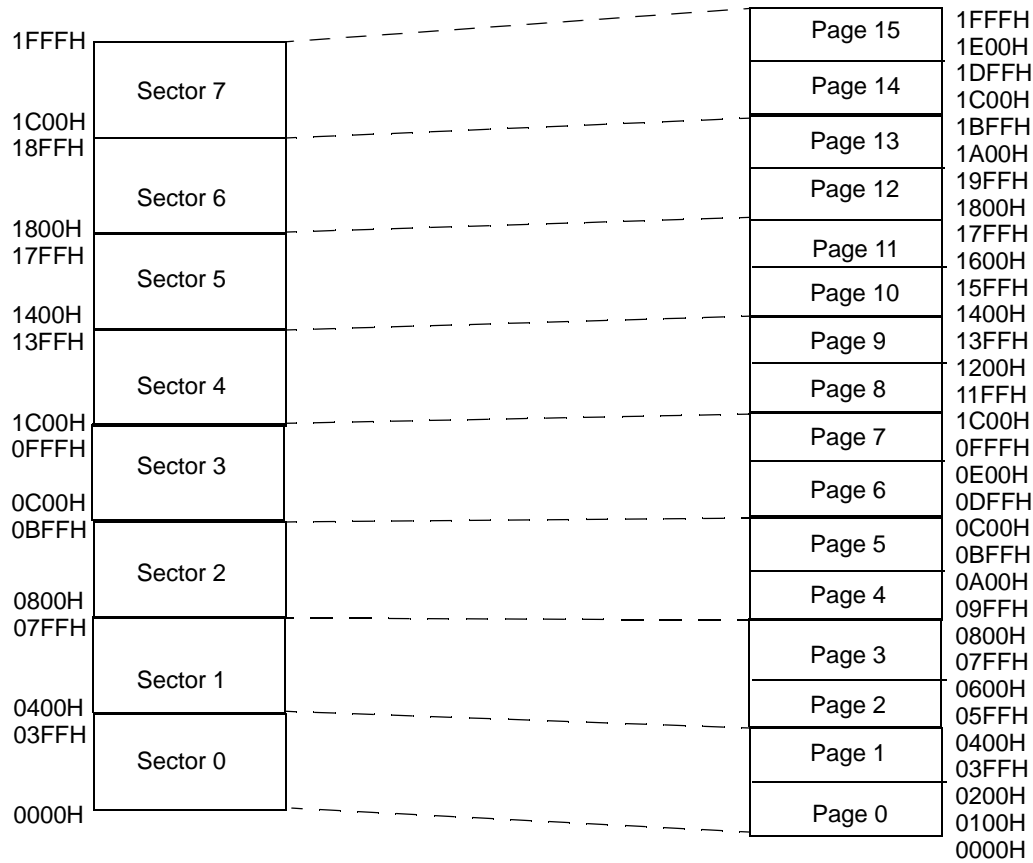


Figure 17. 8K Flash with NVDS

Flash Status Register

The Flash Status Register indicates the current state of the Flash Controller. This register can be read at any time. The read-only Flash Status Register shares its register file address with the write-only Flash Control Register.

Table 73. Flash Status Register (FSTAT)

Bit	7	6	5	4	3	2	1	0
Field	Reserved		FSTAT					
RESET	0	0	0	0	0	0	0	0
R/W	R	R	R	R	R	R	R	R
Address	FF8H							

Bit	Description
[7:6]	Reserved These bits are reserved and must be programmed to 00.
[5:0] FSTAT	Flash Controller Status 000000 = Flash Controller locked. 000001 = First unlock command received (73H written). 000010 = Second unlock command received (8CH written). 000011 = Flash Controller unlocked. 000100 = Sector protect register selected. 001xxx = Program operation in progress. 010xxx = Page Erase operation in progress. 100xxx = Mass Erase operation in progress.

Flash Option Bit Control Register Definitions

This section briefly describes the features of the Trim Bit Address and Data registers.

Trim Bit Address Register

The Trim Bit Address Register, shown in Table 78, contains the target address to access the trim option bits. Trim bit addresses in the range 00h–1Fh map to the information area at addresses 20h–3Fh, as shown in Table 79.

Table 78. Trim Bit Address Register (TRMADR)

Bit	7	6	5	4	3	2	1	0
Field	TRMADR: Trim Bit Address (00H to 1FH)							
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	FF6H							

Table 79. Trim Bit Address Map

Trim Bit Address	Information Area Address
00h	20h
01h	21h
02h	22h
03h	23h
:	:
1Fh	3Fh

Trim Bit Data Register

The Trim Bit Data Register, shown in Table 80, contains the read or write data to access the trim option bits.

Table 80. Trim Bit Data Register (TRMDR)

Bit	7	6	5	4	3	2	1	0
Field	TRMDR: Trim Bit Data							
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	FF7H							

Flash Option Bit Address Space

The first two bytes of Flash program memory at addresses 0000H and 0001H are reserved for the user-programmable Flash option bits. See Tables 81 and 82.

Table 81. Flash Option Bits at Program Memory Address 0000H

Bit	7	6	5	4	3	2	1	0
Field	WDT_RES	WDT_AO	OSC_SEL[1:0]		VBO_AO	FRP	Reserved	FWP
RESET	U	U	U	U	U	U	U	U
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	Program Memory 0000H							

Note: U = Unchanged by Reset. R/W = Read/Write.

Bit	Description
[7] WDT_RES	Watchdog Timer Reset 0 = Watchdog Timer time-out generates an interrupt request. Interrupts must be globally enabled for the eZ8 CPU to acknowledge the interrupt request. 1 = Watchdog Timer time-out causes a system reset. This is the default setting for unprogrammed (erased) Flash.
[6] WDT_AO	Watchdog Timer Always On 0 = On application of system power, Watchdog Timer is automatically enabled. Watchdog Timer cannot be disabled. 1 = Watchdog Timer is enabled on execution of the WDT instruction. Once enabled, the Watchdog Timer can only be disabled by a reset. This is the default setting for unprogrammed (erased) Flash.
[5:4] OSC_SEL	OSCILLATOR Mode Selection 00 = On-chip oscillator configured for use with external RC networks (<4MHz). 01 = Minimum power for use with very low frequency crystals (32 kHz to 1.0MHz). 10 = Medium power for use with medium frequency crystals or ceramic resonators (0.5MHz to 5.0MHz). 11 = Maximum power for use with high frequency crystals (5.0MHz to 20.0MHz). This is the default setting for unprogrammed (erased) Flash.

Power Failure Protection

NVDS routines employ error-checking mechanisms to ensure that any power failure will only endanger the most recently written byte. Bytes previously written to the array are not perturbed. For this protection to function, the VBO must be enabled (see the [Low-Power Modes](#) chapter on page 30) and configured for a threshold voltage of 2.4V or greater (see the [Trim Bit Address Space](#) section on page 129).

A system reset (such as a pin reset or Watchdog Timer reset) that occurs during a write operation also perturbs the byte currently being written. All other bytes in the array are unperturbed.

Optimizing NVDS Memory Usage for Execution Speed

As indicated in Table 93, the NVDS read time varies drastically; this discrepancy being a trade-off for minimizing the frequency of writes that require post-write page erases. The NVDS read time of address N is a function of the number of writes to addresses other than N since the most recent write to address N as well as the number of writes since the most recent page erase. Neglecting the effects caused by page erases and results caused by the initial condition in which the NVDS is blank, a rule of thumb to consider is that every write since the most recent page erase causes read times of unwritten addresses to increase by 0.8 μ s up to a maximum of 258 μ s.

Table 93. NVDS Read Time

Operation	Minimum Latency (μ s)	Maximum Latency (μ s)
Read	71	258
Write	126	136
Illegal Read	6	6
Illegal Write	7	7

► **Note:** For every 200 writes, a maintenance operation is necessary. In this rare occurrence, the write takes up to 58ms to complete.

If NVDS read performance is critical to your software architecture, you can optimize your code for speed by using either of the two methods listed below.

1. Periodically refresh all addresses that are used; this is the more useful method. The optimal use of NVDS, in terms of speed, is to rotate the writes evenly among all addresses planned for use, thereby bringing all reads closer to the minimum read time.

Because the minimum read time is much less than the write time, however, actual speed benefits are not always realized.

2. Use as few unique addresses as possible to optimize the impact of refreshing.

OCD Status Register

The OCD Status Register reports status information about the current state of the debugger and the system.

Table 97. OCD Status Register (OCDSTAT)

Bit	7	6	5	4	3	2	1	0
Field	DBG	HALT	FRPENB	Reserved				
RESET	0	0	0	0	0	0	0	0
R/W	R	R	R	R	R	R	R	R

Bit	Description
[7] DBG	Debug Status 0 = NORMAL Mode. 1 = DEBUG Mode.
[6] HALT	HALT Mode 0 = Not in HALT Mode. 1 = In HALT Mode.
[5] FRPENB	Flash Read Protect Option Bit Enable 0 = FRP bit enabled, that allows disabling of many OCD commands. 1 = FRP bit has no effect.
[4:0]	Reserved These bits are reserved and must be programmed to 00000.

When selecting a new clock source, the primary oscillator failure detection circuitry and the Watchdog Timer Oscillator failure circuitry must be disabled. If POFEN and WOFEN are not disabled prior to a clock switch-over, it is possible to generate an interrupt for a failure of either oscillator. The failure detection circuitry can be enabled anytime after a successful write of OSCSEL in the Oscillator Control Register.

The Internal Precision Oscillator is enabled by default. If the user code changes to a different oscillator, it may be appropriate to disable the IPO for power savings. Disabling the IPO does not occur automatically.

Clock Failure Detection and Recovery

Primary Oscillator Failure

The Z8F04xA family devices can generate nonmaskable interrupt-like events when the primary oscillator fails. To maintain system function in this situation, the clock failure recovery circuitry automatically forces the Watchdog Timer Oscillator to drive the system clock. The Watchdog Timer Oscillator must be enabled to allow the recovery. Although this oscillator runs at a much slower speed than the original system clock, the CPU continues to operate, allowing execution of a clock failure vector and software routines that either remedy the oscillator failure or issue a failure alert. This automatic switch-over is not available if the Watchdog Timer is the primary oscillator. It is also unavailable if the Watchdog Timer Oscillator is disabled, though it is not necessary to enable the Watchdog Timer reset function outlined in the Watchdog Timer chapter of this document.

The primary oscillator failure detection circuitry asserts if the system clock frequency drops below 1 KHz $\pm 50\%$. If an external signal is selected as the system oscillator, it is possible that a very slow but nonfailing clock can generate a failure condition. Under these conditions, do not enable the clock failure circuitry (POFEN must be deasserted in the OSCCTL Register).

Watchdog Timer Failure

In the event of failure of a Watchdog Timer Oscillator, a similar nonmaskable interrupt-like event is issued. This event does not trigger an attendant clock switch-over, but alerts the CPU of the failure. After a Watchdog Timer failure, it is no longer possible to detect a primary oscillator failure. The failure detection circuitry does not function if the Watchdog Timer is used as the primary oscillator or if the Watchdog Timer Oscillator has been disabled. For either of these cases, it is necessary to disable the detection circuitry by deasserting the WDFEN bit of the OSCCTL Register.

The Watchdog Timer Oscillator failure detection circuit counts system clocks while looking for a Watchdog Timer clock. The logic counts 8004 system clock cycles before determining that a failure has occurred. The system clock rate determines the speed at which the Watchdog Timer failure is detected. A very slow system clock results in very slow detection times.

General Purpose I/O Port Input Data Sample Timing

Figure 33 displays timing of the GPIO port input sampling. The input value on a GPIO port pin is sampled on the rising edge of the system clock. The port value is available to the eZ8 CPU on the second rising clock edge following the change of the port value.

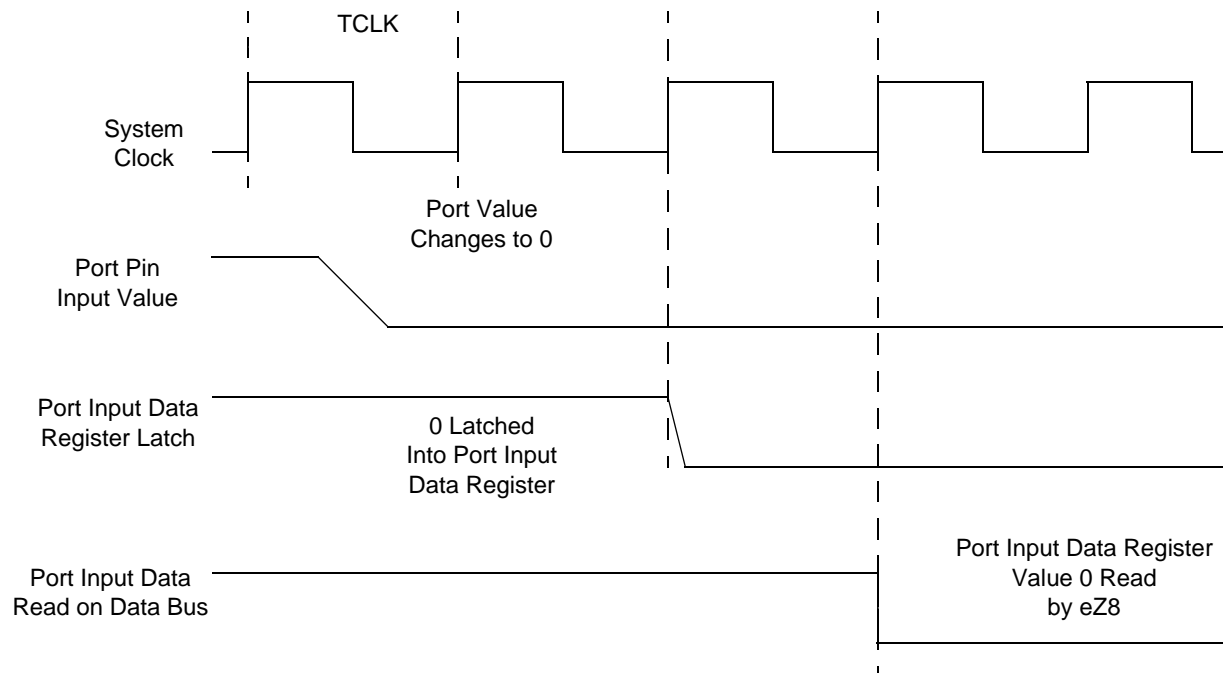


Figure 33. Port Input Sample Timing

Table 124. GPIO Port Input Timing

Parameter	Abbreviation	Delay (ns)	
		Minimum	Maximum
T _{S_PORT}	Port Input Transition to X _{IN} Rise Setup Time (not pictured)	5	–
T _{H_PORT}	X _{IN} Rise to Port Input Transition Hold Time (not pictured)	0	–
T _{SMR}	GPIO port pin pulse width to ensure Stop Mode Recovery (for GPIO port pins enabled as SMR sources)	1 μs	

Analog-to-Digital Converter

For more information about these ADC registers, see the [ADC Control Register Definitions](#) section on page 101.

Hex Address: F70

Table 146. ADC Control Register 0 (ADCCTL0)

Bit	7	6	5	4	3	2	1	0
Field	START	Reserved	REFEN	ADCEN	Reserved	ANAIN[2:0]		
RESET	0	0	0	0	0	0	0	0
R/W	R/W1	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F70h							

Bit	Description
[7] START	ADC Start/Busy 0 = Writing to 0 has no effect; reading a 0 indicates that the ADC is available to begin a conversion. 1 = Writing to 1 starts a conversion; reading a 1 indicates that a conversion is currently in progress.
[6]	This bit is reserved and must be programmed to 0.
[5] REFEN	Reference Enable 0 = Internal reference voltage is disabled allowing an external reference voltage to be used by the ADC. 1 = Internal reference voltage for the ADC is enabled. The internal reference voltage can be measured on the V_{REF} pin.
[4] ADCEN	ADC Enable 0 = ADC is disabled for low power operation. 1 = ADC is enabled for normal use.
[3]	This bit is reserved and must be programmed to 0.
[2:0] ANAIN	Analog Input Select 000 = ANA0 input is selected for analog to digital conversion. 001 = ANA1 input is selected for analog to digital conversion. 010 = ANA2 input is selected for analog to digital conversion. 011 = ANA3 input is selected for analog to digital conversion. 100 = ANA4 input is selected for analog to digital conversion. 101 = ANA5 input is selected for analog to digital conversion. 110 = ANA6 input is selected for analog to digital conversion. 111 = ANA7 input is selected for analog to digital conversion.

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